3.0x2.0mm SURFACE MOUNT LED LAMP

Part Number: AA3021SURSK Hyper Red

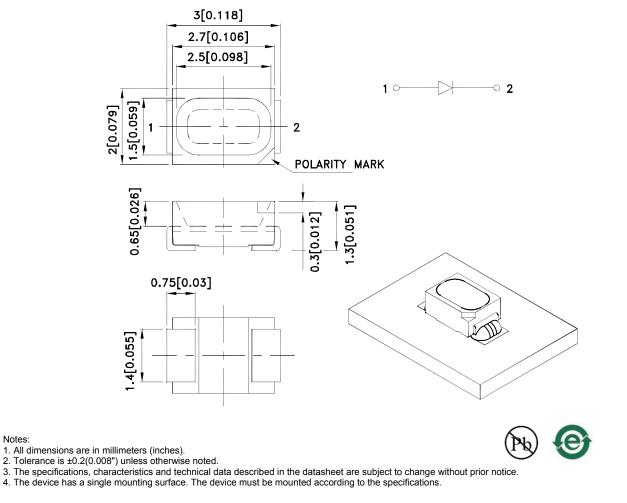
Features

- 3.0mm x 2.0mm, 1.3mm high, only minimum space required.
- Suitable for compact optoelectronic applications.
- Low power consumption.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GalnP on GaAs substrate Light Emitting Diode.

Package Dimensions

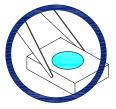


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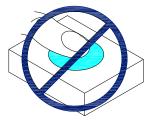
Handling Precautions

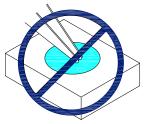
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

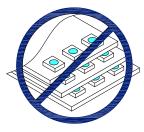


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

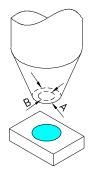




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
i artivo.		Lens Type	Min.	Тур.	201/2
AA3021SURSK	Hyper Red (AlGaInP)	Water Clear	180	320	125°
		Water Clear	*40	*90	

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity/ luminous Flux: +/-15%.
* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.		Тур.		Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650	*645		nm	IF=20mA		
λD [1]	Dominant Wavelength	Hyper Red	630	*630		nm	IF=20mA		
Δλ1/2	Spectral Line Half-width	Hyper Red	28			nm	IF=20mA		
С	Capacitance	Hyper Red	35			pF	VF=0V;f=1MHz		
Vf [2]	Forward Voltage	Hyper Red	1.95		2.5	V	IF=20mA		
IR	Reverse Current	Hyper Red		10	uA	VR=5V			

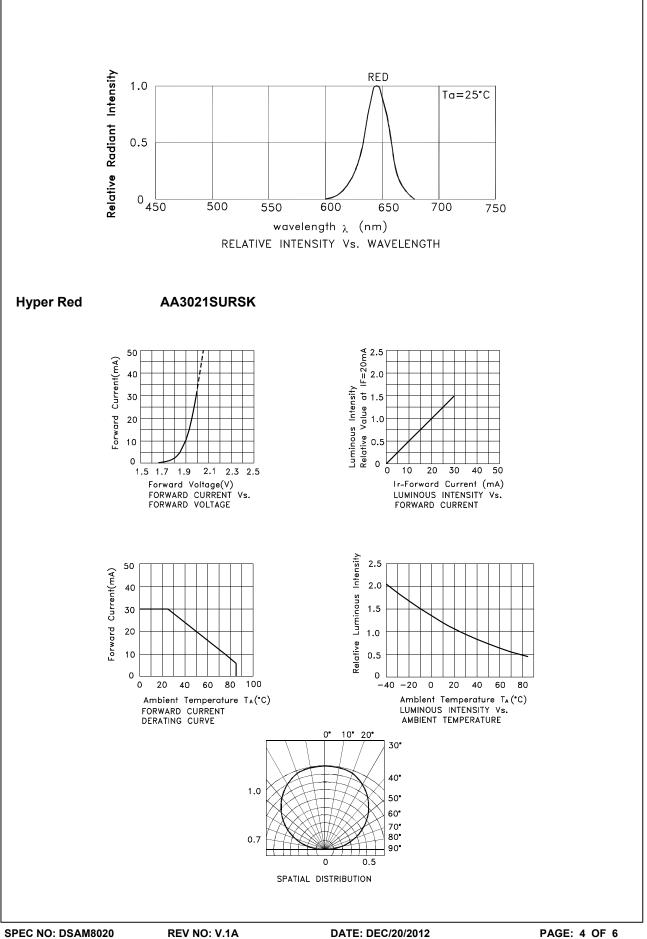
Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V. * Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

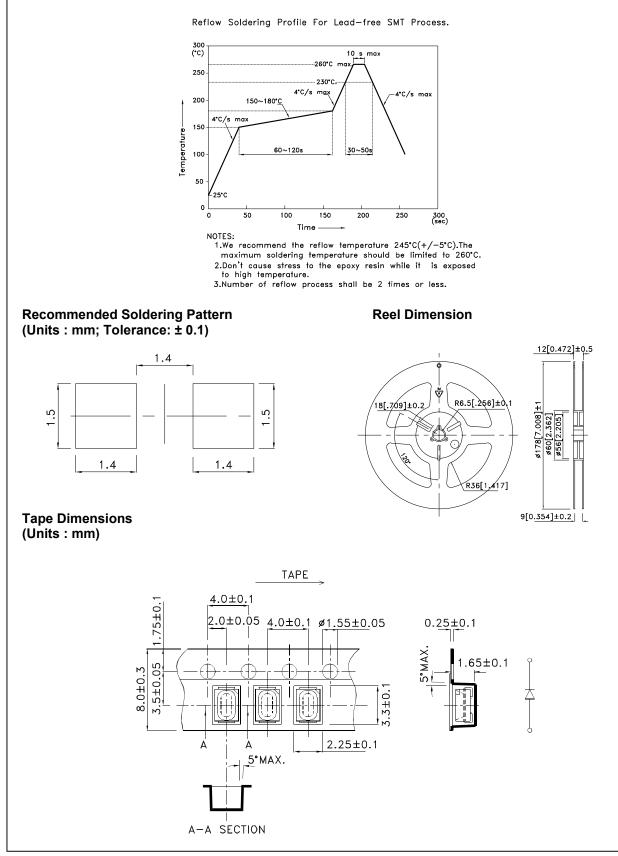
Parameter	Hyper Red	Units			
Power dissipation	75	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	185	mA			
Reverse Voltage	5	V			
Maximum Junction temperature	120	°C			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



AA3021SURSK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.



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